

The RF MOSFET Line 80W, 175MHz, 28V

Designed for broadband commercial and military applications up to 200 MHz frequency range. The high–power, high–gain and broadband performance of this device make possible solid state transmitters for FM broadcast or TV channel frequency bands.

N-Channel enhancement mode MOSFET

- Guaranteed performance at 150 MHz, 28 V: Output power = 80 W Gain = 11 dB (13 dB typ.) Efficiency = 55% min. (60% typ.)
- Low thermal resistance
- Ruggedness tested at rated output power
- Nitride passivated die for enhanced reliability
- Low noise figure 1.5 dB typ at 2.0 A, 150 MHz
- Excellent thermal stability; suited for Class A operation

MAXIMUM RATINGS

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CASE 211-11, STYLE 2

Rating	Symbol		Value		Unit	
Drain–Source Voltage	VDSS		65			
Drain–Gate Voltage	V _{DGO}		65			
Gate-Source Voltage	V _{GS}		±40		Vdc	
Drain Current — Continuous	Ι _D		9.0		Adc	
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	220 1.26			Watts W/∘C	
Storage Temperature Range	T _{stg}		°C			
Operating Temperature Range	TJ		°C			
THERMAL CHARACTERISTICS	·					
Characteristic	Symbol	Symbol Max			Unit	
Thermal Resistance, Junction to Case	R _{eJC}	0.8				
ELECTRICAL CHARACTERISTICS (T _C = 25°C unless otherwise	se noted)	•			•	
Characteristic	Symbol	Min	Typ	Max	Unit	

OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage (V _{DS} = 0 V, V _{GS} = 0 V) I _D = 50 mA V _{(BR)DSS} 65 — _									
Zero Gate Voltage Drain Current (V _{DS} = 28 V, V _{GS} = 0 V)	I _{DSS}	—	—	2.0	mA				
Gate-Source Leakage Current (V _{GS} = 40 V, V _{DS} = 0 V)	I _{GSS}	—	—	1.0	μΑ				
ON CHARACTERISTICS									
Gate Threshold Voltage (V _{DS} = 10 V, I _D = 50 mA)	V _{GS(th)}	1.0	3.0	6.0	V				
Drain-Source On-Voltage (V _{DS(on)} , V _{GS} = 10 V, I _D = 3.0 A)	V _{DS(on)}	—	—	1.4	V				
Forward Transconductance (V _{DS} = 10 V, I _D = 2.0 A)	9 _{fs}	1.8	2.2	_	mhos				

(continued)

NOTE — <u>CAUTION</u> — MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

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ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS					
Input Capacitance (V _{DS} = 28 V, V _{GS} = 0 V, f = 1.0 MHz)	Ciss	_	110	—	pF
Output Capacitance (V _{DS} = 28 V, V _{GS} = 0 V, f = 1.0 MHz)	Coss	—	105	—	pF
Reverse Transfer Capacitance (V _{DS} = 28 V, V _{GS} = 0 V, f = 1.0 MHz)	Crss	_	10	_	pF
FUNCTIONAL CHARACTERISTICS					
Noise Figure (V _{DD} = 28 V, f = 150 MHz, I _{DQ} = 50 mA)	NF	_	1.5	_	dB
Common Source Power Gain (V _{DD} = 28 V, P _{out} = 80 W, f = 150 MHz, I _{DQ} = 50 mA)	G _{ps}	11	13	_	dB
Drain Efficiency (V _{DD} = 28 V, P _{out} = 80 W, f = 150 MHz, I _{DQ} = 50 mA)	η	55	60	_	%
Electrical Ruggedness (V _{DD} = 28 V, P _{out} = 80 W, f = 150 MHz, I _{DQ} = 50 mA) Load VSWR 30:1 at all phase angles	Ψ	No Degradation in Output Power			
Series Equivalent Input Impedance (V _{DD} = 28 V, P _{out} = 80 W, f = 150 MHz, I _{DQ} = 50 mA)	Z _{in}	—	2.99–j4.5	—	Ohms
Series Equivalent Output Impedance (V _{DD} = 28 V, P _{out} = 80 W, f = 150 MHz, I _{DQ} = 50 mA)	Zout	_	2.68–j1.3	_	Ohms

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TYPICAL CHARACTERISTICS

Figure 4. Output Power versus Supply Voltage

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Figure 8. Output Power versus Gate Voltage





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Case Temperature

Figure 11. Capacitance versus Drain Voltage



Figure 12. DC Safe Operating Area



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Table 1. Common Source S–Parameters (V_{DS} = 12.5 V, I_D = 4 A)										
f	S ₁	11	S	21	S	12	S;	22		
MHz	S ₁₁	$\angle \phi$	S ₂₁	∠¢	S ₁₂	$\angle \phi$	\$ ₂₂	$\angle \phi$		
30	0.879	-170	8.09	92	0.014	23	0.839	-174		
40	0.883	-173	6.19	87	0.016	24	0.839	-179		
50	0.885	-174	4.94	84	0.016	28	0.853	-178		
60	0.885	-175	4.21	81	0.017	30	0.845	180		
70	0.888	-176	3.57	77	0.017	34	0.849	179		
80	0.888	-177	3.06	77	0.017	37	0.852	-179		
90	0.888	-178	2.71	76	0.018	42	0.842	-179		
100	0.890	-178	2.45	72	0.019	43	0.858	180		
110	0.888	-179	2.28	70	0.020	46	0.859	179		
120	0.892	-179	2.02	69	0.021	50	0.872	-180		
130	0.893	-179	1.84	67	0.022	52	0.870	-179		
140	0.894	-180	1.73	66	0.023	55	0.880	-180		
150	0.896	-180	1.58	64	0.024	55	0.887	180		
160	0.896	180	1.51	61	0.026	56	0.863	180		
170	0.898	179	1.38	60	0.026	60	0.850	179		
180	0.899	179	1.28	58	0.028	60	0.871	179		
190	0.899	179	1.25	57	0.030	62	0.890	178		
200	0.902	179	1.15	55	0.030	63	0.884	178		
210	0.902	179	1.12	53	0.032	63	0.899	178		
220	0.904	178	1.08	51	0.034	65	0.893	178		
230	0.907	178	0.97	49	0.037	65	0.941	176		
240	0.907	178	0.95	48	0.037	65	0.884	176		
250	0.909	178	0.90	49	0.039	67	0.896	177		
260	0.911	177	0.85	48	0.039	68	0.888	176		
270	0.909	177	0.83	46	0.042	68	0.895	176		
280	0.913	177	0.78	45	0.044	69	0.893	175		
290	0.914	177	0.74	42	0.044	69	0.882	174		
300	0.915	176	0.74	42	0.047	72	0.877	175		
310	0.917	176	0.70	41	0.048	73	0.909	176		
320	0.916	176	0.69	39	0.052	71	0.912	175		
330	0.917	176	0.65	37	0.055	71	0.885	173		
340	0.919	176	0.65	38	0.055	70	0.898	173		
350	0.919	175	0.62	36	0.057	72	0.887	174		
360	0.920	175	0.60	37	0.059	72	0.918	172		
370	0.921	175	0.57	35	0.061	71	0.929	172		
380	0.923	175	0.56	34	0.063	71	0.900	172		
390	0.925	175	0.54	36	0.065	71	0.907	171		
400	0.926	174	0.51	34	0.067	75	0.902	173		
410	0.927	174	0.51	33	0.070	73	0.942	170		
420	0.929	174	0.49	31	0.071	71	0.926	169		
430	0.929	173	0.46	32	0.072	72	0.901	170		





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f	S	11	S	21	S	12	S	22
MHz	S ₁₁	$\angle \phi$	S ₂₁	$\angle \phi$	\$ ₁₂	$\angle \phi$	S ₂₂	$\angle \phi$
450	0.932	173	0.45	29	0.079	75	0.924	170
460	0.932	172	0.44	30	0.082	71	0.938	167
470	0.933	172	0.42	30	0.081	73	0.908	168
480	0.931	172	0.42	29	0.086	72	0.933	168
490	0.931	171	0.41	28	0.089	72	0.926	167
500	0.931	171	0.41	27	0.092	71	0.936	167

Table 1. Common Source S-Parameters (V_{DS} = 12.5 V, I_D = 4 A) (continued)



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Table 2. Common Source S–Parameters (V_{DS} = 28 V, I_D = 4 A)										
f	S ₁₁		\$ ₂₁		\$	12	\$ ₂₂			
MHz	S ₁₁	∠¢	\$ ₂₁	∠¢	S ₁₂	$\angle \phi$	\$ ₂₂	$\angle \phi$		
30	0.840	-163	11.48	92	0.016	20	0.718	-169		
40	0.849	-167	8.80	86	0.017	22	0.713	-174		
50	0.853	-170	6.99	82	0.017	24	0.748	-174		
60	0.854	-171	5.92	79	0.017	23	0.746	-175		
70	0.859	-172	5.00	74	0.018	25	0.746	-175		
80	0.859	-174	4.29	73	0.018	30	0.741	-174		
90	0.861	-174	3.77	71	0.019	38	0.735	-174		
100	0.866	-175	3.39	67	0.018	40	0.768	-176		
110	0.865	-175	3.12	64	0.018	41	0.782	-177		
120	0.871	-176	2.75	63	0.019	42	0.794	-175		
130	0.875	-176	2.49	60	0.021	45	0.783	-172		
140	0.877	-177	2.31	59	0.023	51	0.776	-175		
150	0.883	-177	2.10	56	0.023	55	0.806	-176		
160	0.884	-177	1.99	53	0.023	58	0.807	-176		
170	0.886	-178	1.82	51	0.023	61	0.806	-176		
180	0.890	-178	1.66	49	0.025	59	0.820	-175		
190	0.891	-179	1.62	48	0.027	60	0.815	-176		
200	0.896	-179	1.47	46	0.030	63	0.819	-177		
210	0.898	-179	1.41	43	0.031	67	0.842	-178		
220	0.901	-179	1.36	41	0.032	70	0.855	-178		
230	0.905	-180	1.22	38	0.033	70	0.906	-178		
240	0.906	-180	1.19	38	0.034	67	0.845	-178		
250	0.909	180	1.11	39	0.037	68	0.831	-178		
260	0.913	180	1.03	37	0.038	70	0.837	-180		
270	0.912	179	0.10	35	0.041	72	0.859	179		
280	0.916	179	0.93	34	0.042	74	0.876	178		
290	0.918	179	0.88	31	0.041	73	0.865	179		
300	0.919	178	0.87	31	0.044	74	0.837	-180		
310	0.922	178	0.83	31	0.046	74	0.863	180		
320	0.922	178	0.80	27	0.051	73	0.879	177		
330	0.924	177	0.75	26	0.054	74	0.878	176		
340	0.926	177	0.74	27	0.053	74	0.897	177		
350	0.926	177	0.71	24	0.054	77	0.879	179		



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f	f \$11		\$ ₂₁		S	12	\$ ₂₂	
MHz	\$ ₁₁	$\angle \phi$	\$ ₂₁	$\angle \phi$	S ₁₂	$\angle \phi$	\$ ₂₂	$\angle \phi$
360	0.927	177	0.68	26	0.056	75	0.888	177
370	0.929	177	0.64	24	0.058	73	0.893	175
380	0.931	176	0.62	23	0.062	72	0.885	174
390	0.934	176	0.60	25	0.064	74	0.903	174
400	0.934	176	0.57	22	0.065	78	0.898	177
410	0.936	175	0.56	21	0.068	77	0.931	175
420	0.938	175	0.53	20	0.070	74	0.906	173
430	0.938	174	0.51	21	0.072	73	0.885	173
440	0.939	174	0.49	21	0.075	75	0.895	172
450	0.941	174	0.48	19	0.080	78	0.923	172
460	0.941	173	0.47	19	0.082	75	0.940	171
470	0.942	173	0.45	18	0.080	75	0.904	172
480	0.940	173	0.44	18	0.083	74	0.910	171
490	0.940	172	0.43	18	0.088	72	0.906	169
500	0.940	172	0.42	17	0.092	72	0.927	168

Table 2. Common Source S-Parameters (V_{DS} = 28 V, I_D = 4 A) (continued)

DESIGN CONSIDERATIONS

The MRF173 is a RF MOSFET power N–channel enhancement mode field–effect transistor (FET) designed for VHF power amplifier applications. M/A-COM RF MOSFETs feature a vertical structure with a planar design, thus avoiding the processing difficulties associated with V–groove power FETs.

M/A-COM Application Note AN211A, FETs in Theory and Practice, is suggested reading for those not familiar with the construction and characteristics of FETs.

The major advantages of RF power FETs include high gain, low noise, simple bias systems, relative immunity from thermal runaway, and the ability to withstand severely mismatched loads without suffering damage. Power output can be varied over a wide range with a low power dc control signal, thus facilitating manual gain control, ALC and modulation.

DC BIAS

The MRF173 is an enhancement mode FET and, therefore, does not conduct when drain voltage is applied. Drain current flows when a positive voltage is applied to the gate. See Figure 9 for a typical plot of drain current versus gate voltage. RF power FETs require forward bias for optimum performance. The value of quiescent drain current (IDQ) is not critical for many applications. The MRF173 was characterized at IDQ = 50 mA, which is the suggested minimum value of IDQ. For special applications such as linear amplification, IDQ may have to be selected to optimize the critical parameters.

The gate is a dc open circuit and draws no current. Therefore, the gate bias circuit may generally be just a simple resistive divider network. Some special applications may require a more elaborate bias system.

GAIN CONTROL

Power output of the MRF173 may be controlled from its rated value down to zero (negative gain) by varying the dc gate voltage. This feature facilitates the design of manual gain control, AGC/ALC and modulation systems. (see Figure 8.)

AMPLIFIER DESIGN

Impedance matching networks similar to those used with bipolar VHF transistors are suitable for MRF173. See M/A-COM Application Note AN721', Impedance Matching Networks Applied to RF Power Transistors. The higher input impedance of RF MOSFETs helps ease the task of broadband network design. Both small–signal scattering parameters and large–signal impedances are provided. While the sparameters will not produce an exact design solution for high power operation, they do yield a good first approximation. This is an additional advantage of RF MOS power FETs.

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